# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6735448

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
WOOSEOK NAM	04/09/2021
JING SUN	04/09/2021
TAO LUO	04/10/2021
XIAOXIA ZHANG	04/11/2021
JUAN MONTOJO	04/11/2021
ARUMUGAM CHENDAMARAI KANNAN	04/26/2021
ZHIFEI FAN	04/22/2021
SUNGWOO PARK	04/27/2021

### **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

# **PROPERTY NUMBERS Total: 3**

Property Type	Number
Application Number:	17225867
Application Number:	63007890
Application Number:	63007732

#### **CORRESPONDENCE DATA**

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 5714320800

Email: nstewart-coltrane@harrityllp.com
Correspondent Name: HARRITY & HARRITY, LLP
Address Line 1: 11350 RANDOM HILLS ROAD

Address Line 2: SUITE 600

Address Line 4: FAIRFAX, VIRGINIA 22030

**ATTORNEY DOCKET NUMBER:** 0097-1536/203679

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NAME OF SUBMITTER:	SARA STESNEY
SIGNATURE:	/Sara Stesney/
DATE SIGNED:	05/28/2021
Total Attachments: 10	
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### ASSIGNMENT

# WHEREAS, WE,

- 1. Wooseok NAM, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121, US,
- 2. Jing SUN, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121, US.
- 3. Tao LUO, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121, US.
- 4. Xiaoxia ZHANG, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121, US,
- 5. Juan MONTOJO, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121, US,
- 6. Arumugam CHENDAMARAI KANNAN, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121, US,
- 7. Zhifei FAN, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121. US.
- 8. Sungwoo PARK, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121, US,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **SWITCHING GAP BASED RATE MATCHING** (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout

the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 17/225,867 filed April 8, 2021, Qualcomm Reference Number 203679, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 63/007, 890, filed April 9, 2020, Qualcomm Reference Number 203679P1, together with U.S. Provisional Application No(s). 63/007,732, filed April 9, 2020, Qualcomm Reference Number 203680P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us

respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	San Visigo, A	. on	A(1282)	
	City, State, Country		Date	Wooseok NAM
Done at_		on.		
	City, State, Country		Date	Jing SUN
Done at_		, on _		
	City, State, Country		Date	Tao LUO
Done at_		_, on		
	City, State, Country		Date	Xiaoxia ZHANG
Done at_		on .		
	City, State, Country		Dute	Juan MONTOJO
Done at_		_, on		
	City, State, Country		Date	Arumugam
				CHENDAMARAI KANNAN
Done at_		, on .		
	City, State, Country		Date	Zhifei FAN

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Done at	City, State, Country	n Date	Xiaoxia ZHANG
Done at	City, State, Country	n Date	Juan MONTOJO
Done at	City, State, Country	Date	Arumugam CHENDAMARAI KANNAN
Done at	City, State, Country	on	Zhifei FAN

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				CHENDAMARAI
				KANNAN
Done at				
	City, State, Country		Date	Zhijie FAN

respecting said INVENTIONS, and will restify in any legal proceeding, sign all lawful papers execute all applications and certificates, make all rightful declarations and/or earlis, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns to obtain and enforce patent protection for said INVENTIONS in all countries.

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Done at SS	City, State, Country	<sub>100</sub> 09/11	2 si 23	Xiaoxia ZHANG
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Done at	Care Stone Country	.00	Date	ZulerFAN

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	City, State, Country		Date	Wooseok NAM
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	City, State, Country		Date	Tao LUO
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	City, State, Country		Date	Xiaoxia ZHANG
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	City, State, Country		Date	Juan MONTOJO
Done at		, on		
	City, State, Country		Date	Arumugam CHENDAMARAI KANNAN
Done at		_, on		
	City, State, Country		Date	Zhifei FAN

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		_, on _		
	City, State, Country		Date	Wooscok NAM
Done at	City, State, Country	08	Date	Jing SUN
Done at	City, State, Country	_, on_	Date	Tao LUO
Done at	City, State, Country	_, on _	Date	Xiaoxia ZHANG
Done at	City, State, Country	, on	Date	Juan MONTOJO
Done at <u>lan</u>	Dieso (B) <sup>USP</sup> City, State, Country		04  28   262) Date	Arumugam CHENDAMARAI KANNAN
Done at	City, State, Country	_, on	Date	Zhifei l'AN

PATENT
Qualcomm Reference Number: 283679
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Zhifei FAN	# F .	KANNAN	Arumugam CHENDAMARAI		Juan MONTOJO		Xiaoxia ZHANG		Tao LUO		Jing SUN		Wooseok NAM	

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Qualcomm Reference Number: 203679

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at Carl Country on 4/29/64 Sungwoo PARK

**PATENT** REEL: 056383 FRAME: 0253

**RECORDED: 05/28/2021**